

SME20N65-Z

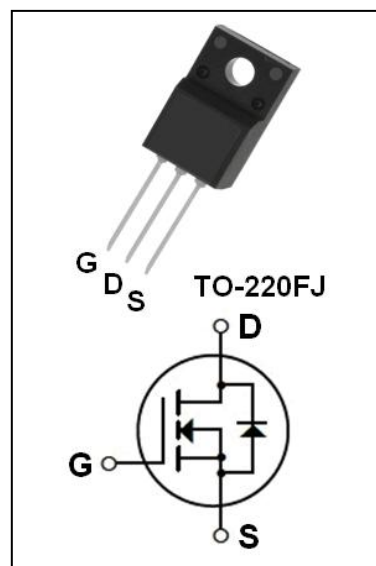
650V N-Channel MOSFET

- **Features:**

- 20.0A, 650V, $R_{DS(on)(Typ)} = 380m\Omega @ V_{GS}=10V$
- Low Gate Charge
- Low C_{rss}
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability

- **Application:**

- High Frequency Switching Mode Power Supply
- Active Power Factor Correction



Absolute Maximum Ratings(Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	650	V
I _D	Drain Current - Continuous(Tc=25°C) - Continuous(Tc=100°C)	20.0*	A
I _{DM}	Drain Current -Pulsed (Note1)	80.0*	A
V _{GSS}	Gate-Source Voltage	± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Limit Reference Value) (Note2)	1078	mJ
I _{AR}	Avalanche Current (Note1)	14.0	A
E _{AR}	Repetitive Avalanche Energy (Note1)	33	mJ
dv/dt	Peak Diode Recovery dv/dt (Note3)	4.5	V/ns
P _D	Power Dissipation(T _C =25°C) -Derate above 25°C	74	W
Tj	Operating Junction Temperature	150	°C
Tstg	Storage Temperature Range	-55 to+150	°C

* Drain Current Limited by Maximum Junction Temperature.

Thermal Characteristics

Symbol	Parameter	Max	Unit
R _{θJC}	Thermal Resistance,Junction to Case	1.69	°C /W
R _{θJA}	Thermal Resistance,Junction to Ambient	62.5	°C /W

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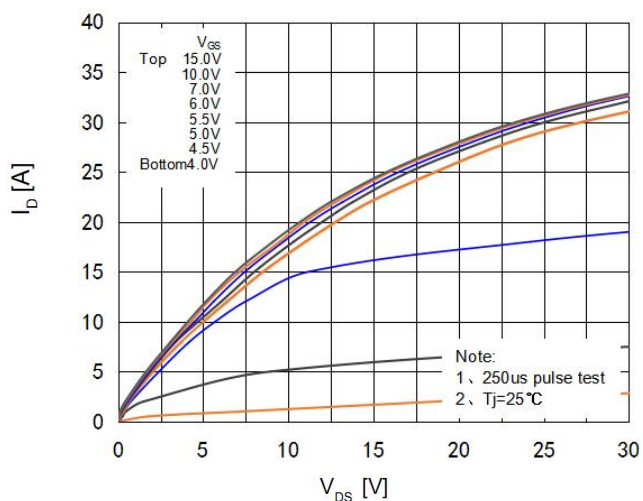
Electrical Characteristics(Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditons	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-source Breakdown Voltage	V _{GS} =0V ,I _D =250μA	650	--	--	V
△BV _{DSS} /△T _J	Breakdown Voltage Temperature Coefficient	I _D =250μA (Referenced to 25°C)	--	0.68	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =650V,V _{GS} =0V	--	--	1	μA
		V _{DS} =520V,Tc=125°C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current,Forward	V _{GS} =+30V, V _{DS} =0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current,Reverse	V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =10.0A	--	380	450	mΩ
g _{FS}	Forward Transconductance	V _{DS} =20 V, I _D =10.0A (Note4)	--	21	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =25V,V _{GS} =0V, f=1.0MHz	--	3480	--	pF
C _{oss}	Output Capacitance		--	239	--	pF
C _{rss}	Reverse Transfer Capacitance		--	7	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 325 V, I _D = 20 A, R _G = 25 Ω (Note4,5)	--	27.0	--	ns
t _r	Turn-On Rise Time		--	44.1	--	ns
t _{d(off)}	Turn-Off Delay Time		--	81.7	--	ns
t _f	Turn-Off Fall Time		--	43.5	--	ns
Q _g	Total Gate Charge	V _{DS} = 520 V, I _D =20 A, V _{GS} = 10 V (Note4,5)	--	56	--	nC
Q _{gs}	Gate-Source Charge		--	14.5	--	nC
Q _{gd}	Gate-Drain Charge		--	23.4	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	20	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	80	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} =0V,I _S =20 A	--	--	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =20 A, d I _F /dt=100A/μs (Note4)	--	588	--	ns
Q _{rr}	Reverse Recovery Charge		--	7.57	--	μC

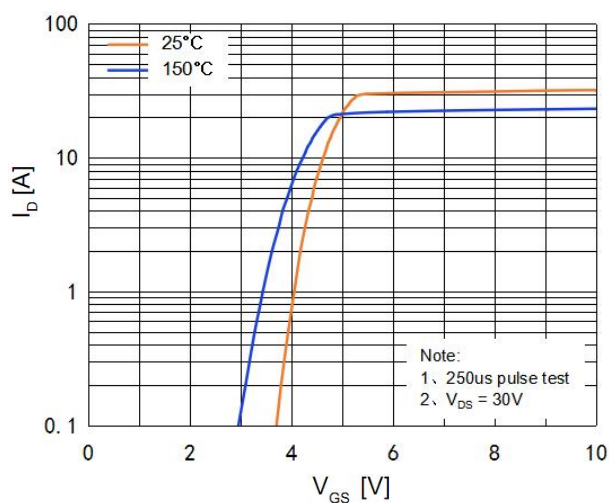
Notes:

- 1、Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
- 2、L = 10.0mH, $I_{AS}=14.0A$, $V_{DD}=100V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$.
- 3、 $I_{SD}\leq 20.0A$, $di/dt\leq 200A/\mu s$, $V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ C$.
- 4、Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
- 5、Essentially Independent of Operating Temperature.

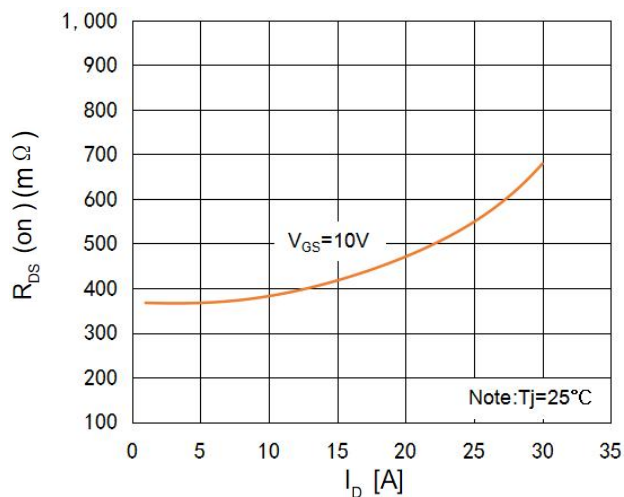
On-Regin Characteristics



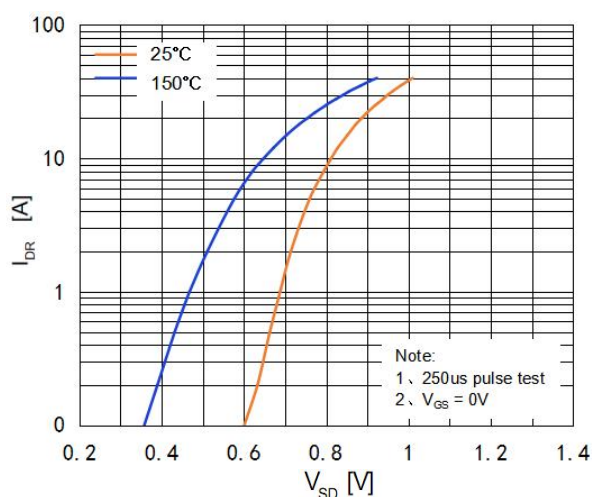
Transfer Characteristics



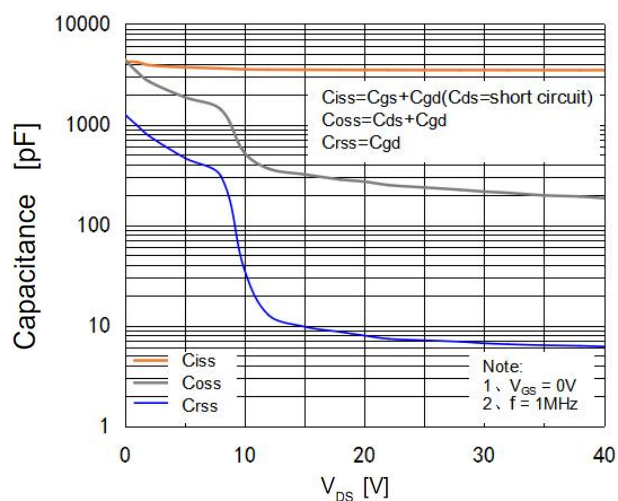
On-Resistance Variation vs. Drain Current and Gate Voltage



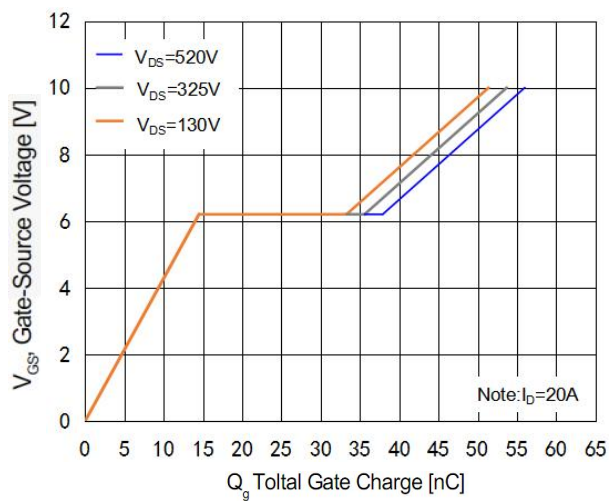
Body Diode Forward Voltage Variation vs. Source Current and Temperature



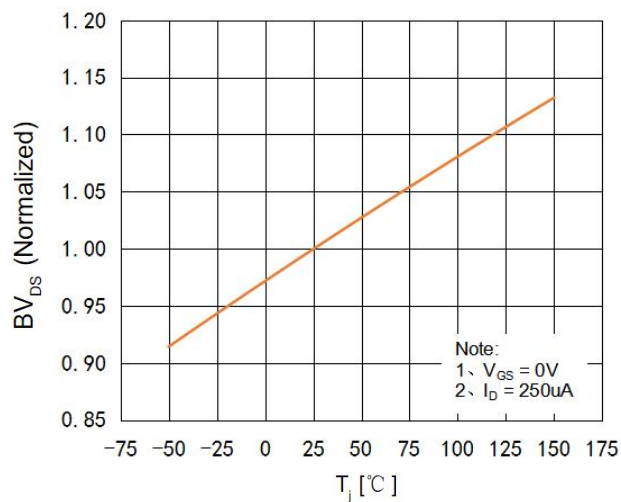
Capacitance Characteristics



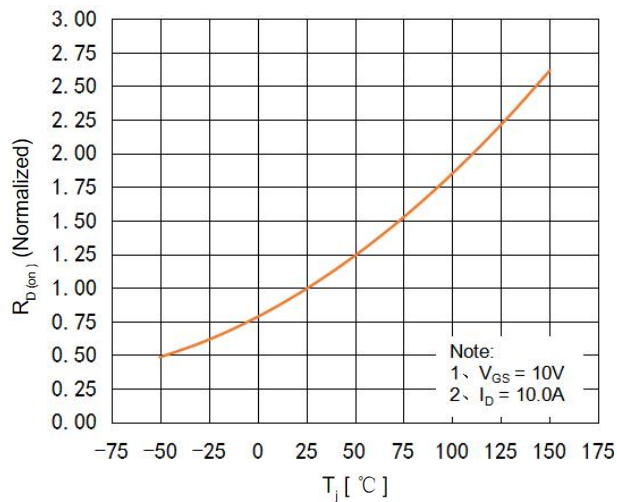
Gate Charge Characteristics



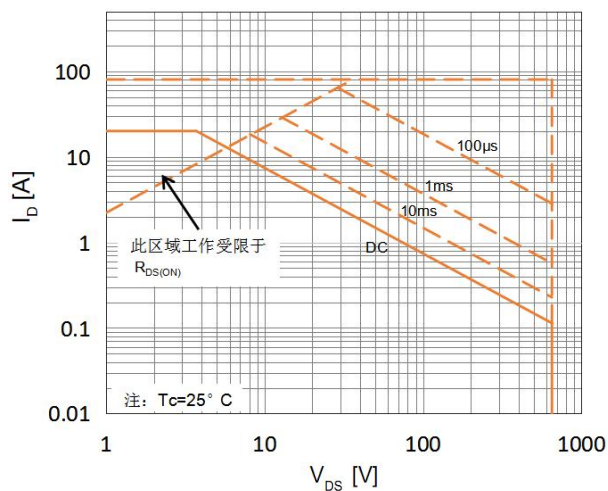
Breakdown Voltage Variation vs. Temperature



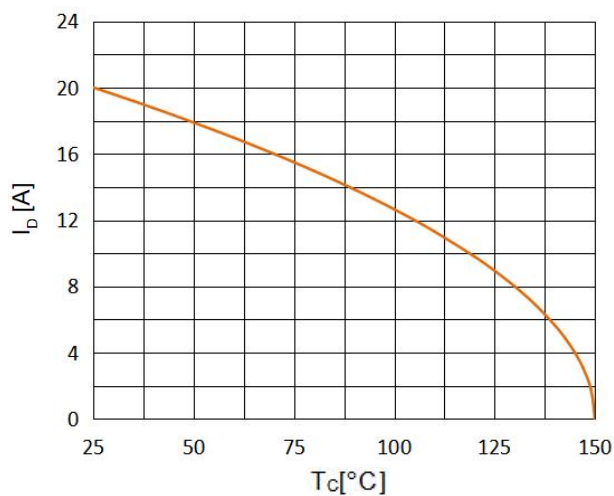
On-Resistance Variation vs. Temperature



Maximum Safe Operating Area



Maximum Drain Current Vs. Case Temperature





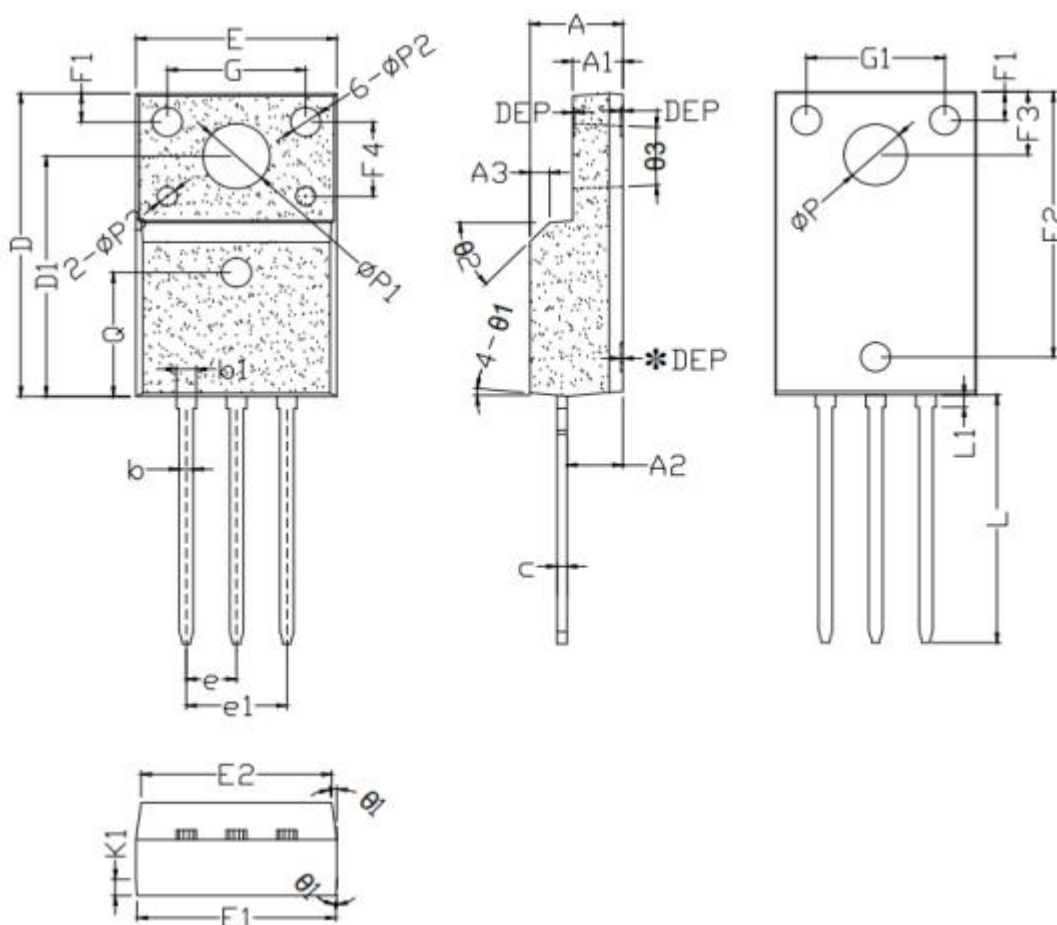
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TO-220FJ (窄脚) Package Dimensions

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.50	4.70	4.90	F3	3.10	3.30	3.50
A1	2.34	2.54	2.74	F4	3.70	3.90	4.10
A2	2.56	2.76	2.93	G1	6.80	7.00	7.20
A3	1.0REF			K1	0.60	0.70	0.80
b	0.60	0.70	0.80	L	11.98	12.98	13.98
b1	0.90	1.00	1.10	L1	-	-	0.95
c	0.40	0.50	0.60	Q	6.50REF		
D	15.47	15.87	16.27	ΦP	2.98	3.18	3.38
D1	12.17	12.57	12.97	ΦP1	3.20	3.40	3.60
e	2.54REF			ΦP2	1.30	1.50	1.70
e1	5.08REF			ΦP3	0.80	1.00	1.20
E	9.86	10.16	10.46	θ 1	3°	5°	7°
E1	9.76	10.06	10.36	θ 2	40°	45°	50°
E2	9.10	9.40	9.70	θ 3	3°	5°	7°
F1	1.30	1.50	1.70	DEF	0.05	0.10	0.20
F2	13.60	13.90	14.20				



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注意事项：

- 1、在电路设计时请不要超过器件的最大额定值，否则会影响整机的可靠性。
- 2、MOSFET产品为静电敏感型器件，使用时应注意采取防静电保护措施，如佩戴防静电手环、设备接地等。
- 3、如需安装散热片，请注意控制扭力大小及散热片的平整度。
- 4、该规格书由华科公司制作，并可能不定期更改，恕不另行通知。
- 5、如有疑问，请及时联系我司销售代表。

版本履历表：

序号	版本号	修改时间	修改记录
1	V1.0	2023-9-28	首次发行